

January 2012

# **S320**

# 3A, 200V, Surface Mount Package Schottky Rectifier

## **Features**

- Low Profile, Mini Surface Mount Package: SMB / DO-214AA
- High Reverse Voltage: V<sub>RRM</sub> = 200V
- Low Power Loss, High Efficiency
- High Surge Current: I<sub>FSM</sub> = 80A
- RoHS 2002/95/EC Compliant



SMB / DO-214AA
Color Band Denotes Cathode
Mark: S320

# **Absolute Maximum Ratings**\* T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
$V_{RRM}$	Maximum Repetitive Peak Reverse Voltage	200	V
V <sub>RMS</sub>	Maximum RMS Voltage	140	V
$V_{DC}$	Maximum DC Blocking Voltage	200	V
I <sub>F(AV)</sub>	Maximum Average Forward Current	3.0	Α
I <sub>FSM</sub>	Non-repetitive Peak Forward Surge Current : 8.3ms Single Half-Sine-Wave superimposed on rated load (JECEC method)	80	A
T <sub>STG,</sub> T <sub>J</sub>	Operating Junction and Storage Temperature Range	-65 to +150	°C

<sup>\*</sup> These ratings are limiting values above which the serviceability of any semiconductor device may by impaired.

# Thermal Characteristics\*

Symbol	Parameter	Тур.	Units
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	160	°C/W
$\Psi_{JL}$	Junction to Lead Thermal Characteristics	20	°C/W

<sup>\*</sup> Test condition - Test environment & PCB type: JESD51-2,3, Board size: 76.2x114.3mm,

Pad size: 2.5x2.2mm, Trace width: 30mils

# **Electrical Characteristics** $T_A = 25$ °C unless otherwise noted

Symbol	Parameter	Test Condition	Тур.	Max.	Units
V <sub>F</sub>	Forward Voltage*	@ 3.0A		0.9	V
I <sub>R</sub>	DC Reverse Current	@ Rated $V_{DC}$ $T_A = 25^{\circ}C$		7	μΑ
		T <sub>A</sub> = 100°C		120	μΑ
trr	=	$I_F$ =0.5A, $I_R$ =1A, $I_{RR}$ =0.25A	14		ns
trr	Reverse recovery time	I <sub>F</sub> =1A, V <sub>R</sub> =-30V, I <sub>RR</sub> =10% I <sub>RM</sub> , di/dt=50A/μs	30		ns
		I <sub>RR</sub> =10% I <sub>RM</sub> , di/dt=50A/μs			

<sup>\*</sup> Pulse Test with PW = 250µsec, 2% Duty Cycle.

<sup>\*\*</sup> I<sub>R</sub> < 1A due to fast reverse recovery

# **Typical Performance Characteristics**

Figure 1. DC Forward Current Derating Curve

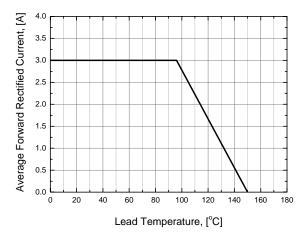
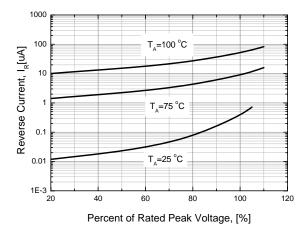


Figure 3. Typical Reverse Characteristics



**Figure 2. Forward Current Characteristics** 

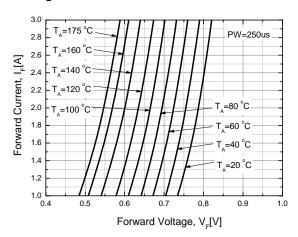
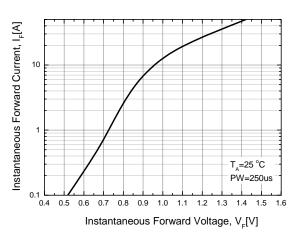


Figure 4. Typical Instantaneous Forward Characteristic





# (h)

#### **TRADEMARKS**

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

2Cool™ F-PFS™ AccuPower™ FRFET®

AX-CAP™\* Global Power Resource<sup>SM</sup>
BitSiC™ GreenBridge™
Build it Now™ Green FPS™

CorePLUSTM Green FPSTM e-SeriesTM
CorePOWERTM GmaxTM CROSSVOLTTM GTOTM

CTLTM IntelliMAXTM
Current Transfer LogicTM ISOPLANARTM

Current Transfer Logic™ ISOPLANAR™

DEUXPEED® Making Small Speakers Sound Louder

Dual Cool™ and Better™
EcoSPARK® MegaBuck™
EfficientMax™ MICROCOUPLER™

ESBC™ MicroFET™ **■**® MicroPak™ MicroPak2™ Fairchild® MillerDrive™ Fairchild Semiconductor® MotionMax™ FACT Quiet Series™ Motion-SPM™ FACT® FAST® mWSaver™ OntoHiT™ FastvCore™ OPTOLOGIC®

FETBench<sup>TM</sup> OPTOPLANAR®
FlashWriter®\*

PowerTrench<sup>®</sup> PowerXS<sup>™</sup>

Programmable Active Droop™

QFET<sup>®</sup> QS™

Quiet Series™ RapidConfigure™

O'<sup>™</sup> Saving our world, 1mW/W/kW at a time™

SignalWise™ SmartMax™ SMART START™

Solutions for Your Success™

SPM®
STEALTH™
SUPERSOT™-3
SUPERSOT™-3
SUPERSOT™-6
SUPERSOT™-8
SUPERMOS®
SYNCFET™
SYNC-LOCK™
SYSTEM
GENERAL®-

The Power Franchise®
the pwer\*
franchise

Tranchise
TinyBoost™
TinyBuck™
TinyCalc™
TinyLogic®
TINYOPTO™
TinyPower™
TinyPWM™
TinyWM™
TranSiC™
TranSiC™
TriPault Detect™
TRUECURRENT®\*

SerDes"
UHC®
Ultra FRFET™
UniFET™
VCX™
VisualMax™
VoltagePlus™

μSerDes™

\* Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

#### DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

## LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

## As used herein:

- Life support devices or systems are devices or systems which, (a)
  are intended for surgical implant into the body or (b) support or
  sustain life, and (c) whose failure to perform when properly used in
  accordance with instructions for use provided in the labeling, can be
  reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

## ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

## PRODUCT STATUS DEFINITIONS

## **Definition of Terms**

Deminion of Terms		
Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. I61